

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Gary M. Zalewski	12/04/2008
Richard Marks	12/09/2008
Xiadong Mao	11/11/2008
RECEIVING PARTY DATA	
Name:	Sony Computer Entertainment Inc.
Street Address:	2-6-21 Minami-Aoyama, Minato-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	107-0062
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12262044
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	92185/7528
NAME OF SUBMITTER:	Richard E. Wawrzyniak
Total Attachments: 2 source=92185_ExecutedAssignment#page1.tif source=92185_ExecutedAssignment#page2.tif	

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PATENT

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REEL: 022130 FRAME: 0737

Docket No. 92185 (7528)

ASSIGNMENT

WHEREAS, I, as a below named inventor, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

METHOD AND APPARATUS FOR TRACKING THREE-DIMENSIONAL MOVEMENTS OF AN OBJECT USING A DEPTH SENSING CAMERA

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name;

AND WHEREAS, Sony Computer Entertainment Inc., a Japanese corporation with offices at 2-6-21 Minami-Aoyama, Minato-ku, Tokyo 107-0062 Japan (hereinafter referenced as **ASSIGNEE**) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefore in the United States and in any and all foreign countries;

NOW THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said **ASSIGNEE**, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said **ASSIGNEE**, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of **ASSIGNEE** or its designee, as **ASSIGNEE** or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the **ASSIGNEE** thereof shall hereafter require and prepare at its own expense;

And I further agree that **ASSIGNEE** will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;


Docket No. 92185 (7528)

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow:
Application Number: 12/262,044, Filing Date: October 30, 2008.

This assignment is being executed on the date indicated below.

Gary M. Zalewski
Name of First or Sole Inventor

Oakland, CA
Residence of First or Sole Inventor



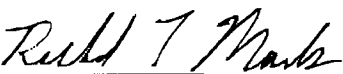
Signature of First or Sole Inventor

12/14/08

Date of this Assignment

Richard Marks
Name of Second Inventor

Foster City, CA
Residence of Second Inventor



Signature of Second Inventor

RLM
Richard Marks 12-09-08

Date of this Assignment

Xiadong Mao
Name of Third Inventor

Foster City, CA
Residence of Third Inventor



Signature of Third Inventor

11-11-2008

Date of this Assignment